Data Sheet
5mm PIN Photodiode

PD333C

Features

- Fast response time
- High photo sensitivity
- Small junction capacitance

Descriptions

PD333C is a high speed and high sensitive PIN photodiode in a standard 5 ϕ plastic package. The device is spectrally matched to infrared emitting diode.

Applications

- High speed photo detector
- Security system
- Camera

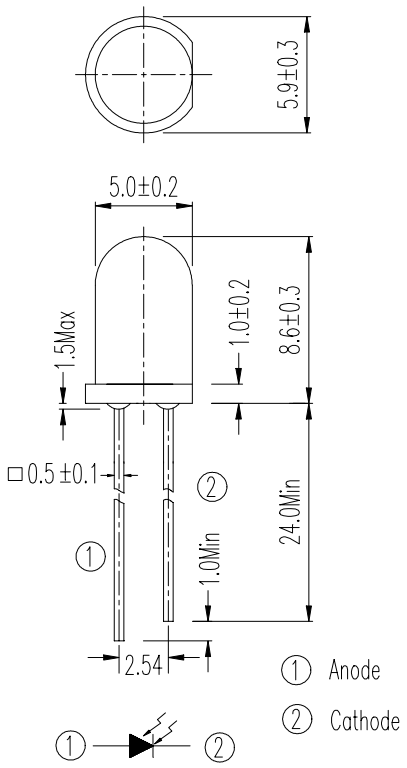
Device Selection Guide

LED Part No.	Chip Material	Lens Color
PD	Silicon	Water clear

Device No:DPD-033-070

PD333C

Package Dimensions



Notes: 1.All dimensions are in millimeters
2.Tolerances unless dimensions ± 0.25mm

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Units
Reverse Voltage	V_R	32	V
Power Dissipation	Pd	150	mW
Lead Soldering Temperature	Tsol	260	℃
Operating Temperature	Topr	-25 ~ +85	℃
Storage Temperature	Tstg	-40 ~ +85	℃

Notes: *1:Soldering time≦5 seconds.

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Electro-Optical Characteristics (Ta=25℃)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Units
Rang of Spectral Bandwidth	$\lambda_{0.5}$	-----	---	400-1100	---	nm
Wavelength of Peak Sensitivity	λ_p	-----	---		---	nm
Open-Circuit Voltage	V_{OC}	Ee=5m W/cm^2 λ p=940nm	---	0.41	---	V
Short- Circuit Current	I_{SC}	Ee=1m W/cm^2 λ p=940nm	---	20	---	μA
Reverse Light Current	I_L	Ee=1m W/cm^2 λ p=940nm V_R=5V	---	20	---	
Dark Current	Id	Ee=0m W/cm^2 V_R=10V	---	---	10	nA
Reverse Breakdown	BV_R	Ee=0m W/cm^2 I_R=100 μA	32	170	---	V
Total Capacitance	Ct	Ee=0m W/cm^2 V_R=5V f=1MHZ	---	6	---	pF
Rise/Fall Time	t_r/t_f	V_R=10V R_L=1000Ω	---	10/10	---	nS

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Typical Electro-Optical Characteristics Curves

Fig. 1 Power Dissipation vs. Ambient Temperature

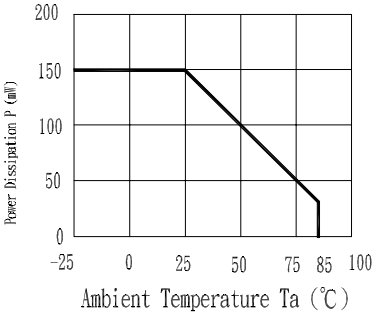


Fig.2 Spectral Sensitivity

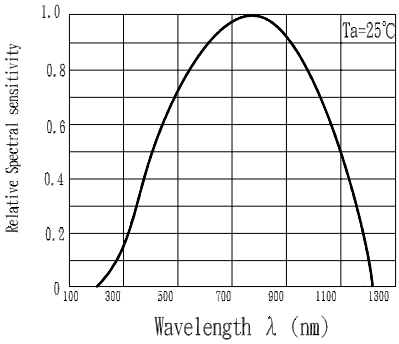


Fig.3 Dark Current vs. Ambient Temperature

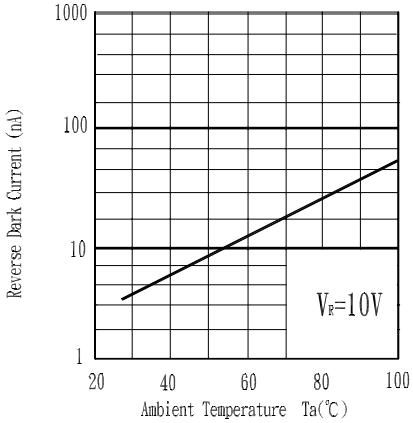


Fig.4 Reverse Light Current vs.Ee

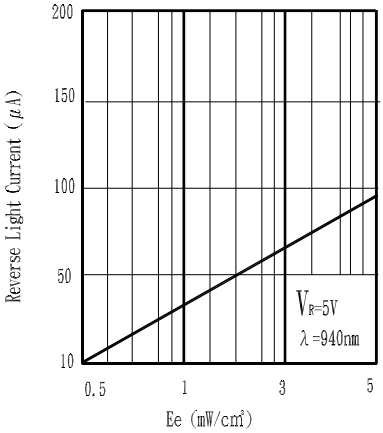


Fig.5 Terminal Capacitance vs. Revere Voltage

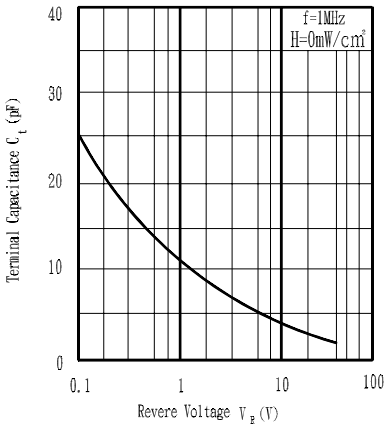
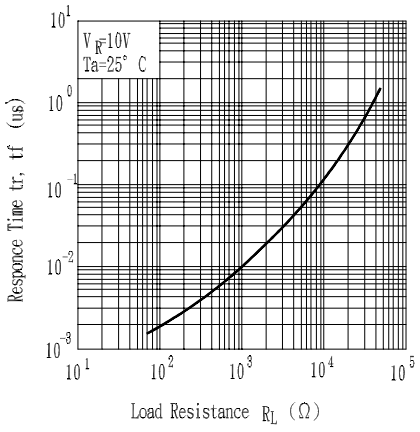


Fig.6 Responce Time vs. Load Resistance



Device No:DPD-033-070

Reliability Test Item And Condition

The reliability of products shall be satisfied with items listed below.

Confidence level：90%

LTPD：10%

NO.	Item	Test Conditions	Test Hours/ Cycles	Sample Sizes	Failure Judgement Criteria	Ac/Re
1	Solder Heat	TEMP :260℃± 5℃	10secs	22pcs	I_R≧U× 2 Ee≦L× 0.8 V_F≧U× 1.2 U：Upper Specification Limit L：Lower Specification Limit	0/1
2	Temperature Cycle	H : +85℃ 30mins 5mins L : -55℃ 30mins	50Cycles	22pcs		0/1
3	Thermal Shock	H :+100℃ 5mins 10secs L :-10℃ 5mins	50Cycles	22pcs		0/1
4	High Temperature Storage	TEMP.：+100℃	1000hrs	22pcs		0/1
5	Low Temperature Storage	TEMP.：-55℃	1000hrs	22pcs		0/1
6	DC Operating Life	V_R=5V	1000hrs	22pcs		0/1
7	High Temperature/ High Humidity	85℃ / 85% R.H	1000hrs	22pcs		0/1